2835 BLUE LED Datasheet



Features:

Slim Size SMD Package: Design Flexibility
High Lumen Output and High Radiant Flux
Stable Performance & Great CCT Unity
R, G, B, Y, A, UV, IR Light Color Available
Full Wavelength 365-850nm Available
Environmental Friendly; ROHS Compliance
Customized Service Available

Applications:

LED Module, Illuminated Advertising
Tube Light, Panel Light, Ceiling Lamp and other LED Indoor Lights
Flood Light, High Bay Light, Tunel Light and other LED Outdoor Lights
LED Aquarium Light, LED Plant Growing Light..



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PRODUCT NAMING RULES

LKL	XXXX	XX	X	X	XXX
LKL	Туре	Light Color	Chip QTY	Beam Angle	Brightness
Lekoled	2835	V1: 360-370nm	1: 1EA	0: 120°/140°	02: 2-3LM
		V2: 370-380nm	2: 2EA		04: 4-5LM
		V3: 380-390nm	3: 3EA		05: 5-6LM
		V4: 390-400nm			10: 10-12LM
		V5: 400-410nm			18: 18-20LM
		V6: 410-420nm			
		RB: 440-450nm			05M: 50-100mcd
		B2: 450-460nm			2M: 200-250mcd
		B3: 460-470nm			5M: 500-550mcd
		G2: 520-530nm			8M: 800-850mcd
		Y4: 585-595nm			15M: 1500-1800mcd
		A6: 600-610nm			
		R1: 620-630nm			
		DR: 660-665nm			



CHARACTERISTICS

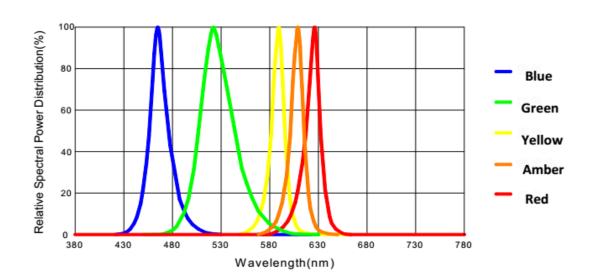
Light Color	Wavelength (nm)	2.8-3.4V @150mA	Model No.	
Light Color	wavelength (mm)	Luminous Flux	Model No.	
Blue	440-450	6-8LM	LKL-2835RB1006	

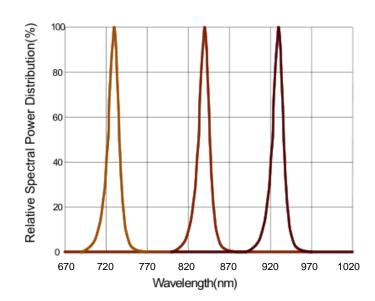
Absolute Maximum Ratings at Tj=25°C				
Parameters	Symbol	Value	Unit	
Forward Current	I _F	150	mA	
Peak Pulsed Forward Current	I _{FP}	200	mA	
Power Dissipation	P_{D}	0,5	W	
Reverse Voltage	VR	5	V	
Viewing Angle	2θ 1/2	120	Deg	
Operating Temperature	T_{OPR}	-40 ~ +60	°C	
Storage Temperature	T_{STG}	-40 ~ +85	°C	
Junction Temperature	T _j	115	°C	
Soldering Temperature	T _{SLD}	Reflow Soldering: 230°C or 260°C for 10Sec		

Electrical/ Optical Characteristics at Tj=25°C						
Parameters	Symbol	Min	Туре	Max	Unit	Condition
Forward Voltage	V _F	2.8		3.4	V	IF=150mA
Reverse Current	IR		10		μΑ	VR=5V
Radiant Flux	Фе	6		8	LM	IF=150mA
Wavelength	λр	440	445	450	nm	IF=150mA
Thermal Resistance	Rth j-sp		8		°C/W	IF=150mA
Electrostatic Discharge	ESD		2000		V	НВМ



RELATIVE SPECTRAL POWER DISTRIBUTION

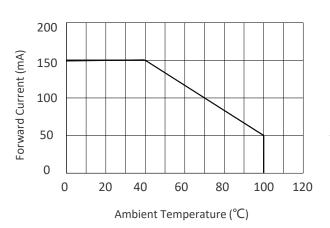


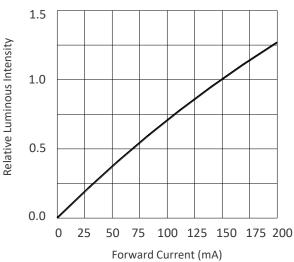


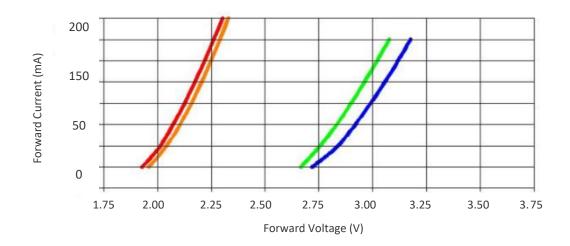


TYPICAL CHARACTERISTIC CURVES

Specifications (IF=60mA, Tc=25 ℃)









RELIABILITY TESTS

Test Items	Test Conditions	Sample QTY	Ac/Re
Aging Tost	IF=150mA, Ta=25℃ x6000hrs	22	0/1
Aging Test	IF=150mA, Ta=85℃ x6000hrs	22	0/1
High Temperature Storage	100°C x1000hrs	22	0/1
Low Temperature Storage	-40°C x1000hrs	22	0/1
High Temp & Humidity	IF=150mA, 85 °C, 85% RH for 6000hrs	22	0/1
Temperature Shock	-40℃x30 min & +100℃x30 min, 100cycle	22	0/1
ESD(HBM)	2000V HBM/ 1 Time	10	0/1

Criteria for Judging LED Failure (Tc= 25 $^{\circ}$ C)

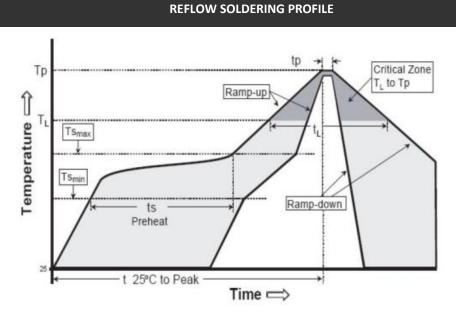
Items	Symbol	Test Conditions	Criteria for Judging LED Failure
Forward Voltage	VF	IF=150mA	>U x 1.1
Reverse Current	IR	VR=5V	IR>/= 10μA
Lumen	ФV	IF=150mA	<\$ x 0.7

U refers to max value; S refers to initial value.

Notes: Judging criteria based on Tc=25 $^{\circ}\! C$.



TYPICAL CHARACTERISTIC CURVES

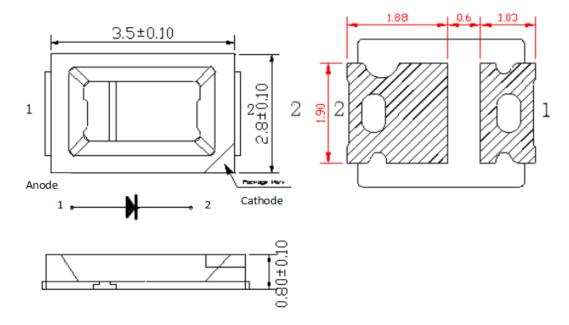


Profile Features	Lead-free solder	Lead solder	Soldering by Manual
Ramp-up Speed(Ts max to Tp)	3 °C/ second max.	3 °C/ second max.	
Preheat: Min. Temperature(Tsmin)	150 °C	100 °C	
Preheat: Max.Temperature(Tsmax)	200 °C	150 °C	
Preheat: Time (tsmin to tsmax)	60~180 seconds	60~120 seconds	
Temperature to Keep: (TL)	217 °C	183 °C	Max. temperature: 350°C
Time to Keep: (tL)	60~150 seconds	60~150 seconds	3 seconds/1 time
Peak Temperature (Tp)	260 °C	215 °C	
Time within the peak temperature	20~40 seconds	10~30 seconds	
Ramp-down Speed	6°C/ second max.	6°C/ second max.	
Time to the peak Temperature	8 minutes max.	6 minutes max.	



DIMENSIONS

Unit: mm



Notes:

*All dimensions are in millimeters.(tolerance:±0.2mm)

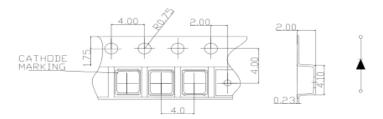
*The appearance and specifications of the product may be changed for improvement without notice.

^{*}The mark is anode.

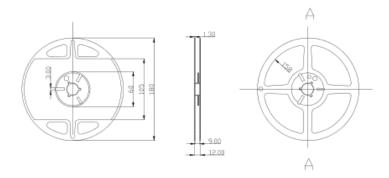


PACKAGING

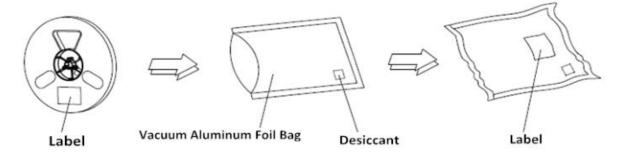
Tape Specifications (Units: mm)



Reel Dimensions



Moisture Resistant Packaging





PRECAUTIONS

Storage

- 1. Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to aminimum.
- 2. Before opening the package, the product should be kept at 30 °C or less and humidity less than 60% RH, and beused within a year.
- 3. After opening the package, the product should be stored at 30° C or less and humidity less than 10%RH, and besoldered within 24 hrs (1day). It is recommended that the product be operated at the workshop condition of 30° C or less and humidity less than 60%RH.
- 4. If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (80±5)°C for 24 hours.

Static Electricity

- 1. Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.
- 2. All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or antielectrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

Vulcanization

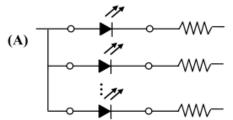
LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag2S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline, seriously affecting the performance of the product. So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

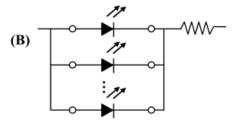
Design Consideration

- 1. In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen.
- 2. It is recommended to use Circuit A which regulates the current flowing through each LED rather than Circuit B.

 When driving LEDs with a constant voltage in Circuit B, the current through the LEDs may vary due to the variation in Forward Voltage

 (VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the Absolute Maximum Rating.





3. Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color changed and so on. Please consider the heat generation of the LEDs when making the system design.



PRECAUTIONS

Safety Advice For Human Eyes

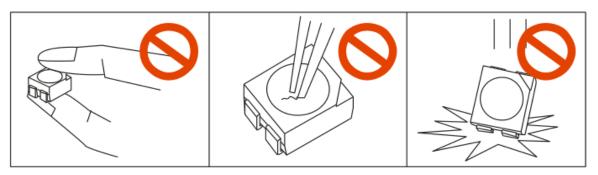
Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity will cause great hazard to human eyes. Please be careful.

The safe temperature for LEDs working

The high temperature will make the LEDs' Luminous Intensity decreased radically, if LEDs worked in hoteyes. Please be careful. environment for a long time, they will be disabled easily. When LEDs are working in a closed array, we suggest that the LEDs' surface temperature should be lower than 55° C and the legs' temperature should be lower than 75° C.

Others

1. When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to Die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



2. The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.